



US 20150309373A1

(19) **United States**(12) **Patent Application Publication**
KUNIMATSU et al.(10) **Pub. No.: US 2015/0309373 A1**(43) **Pub. Date: Oct. 29, 2015**(54) **LIQUID CRYSTAL DISPLAY DEVICE****Publication Classification**(71) Applicants: **Noboru KUNIMATSU**, Chiba (JP);
Yuko MATSUMOTO, Onjuku (JP);
Yasushi TOMIOKA, Mobara (JP);
Masateru MORIMOTO, Mobara (JP);
Atsuhiko KATAYAMA, Mobara (JP)(51) **Int. Cl.**
G02F 1/1337 (2006.01)
G02F 1/1368 (2006.01)
G02F 1/1335 (2006.01)
G02F 1/1362 (2006.01)
G02B 5/20 (2006.01)
G02F 1/1339 (2006.01)(72) Inventors: **Noboru KUNIMATSU**, Chiba (JP);
Yuko MATSUMOTO, Onjuku (JP);
Yasushi TOMIOKA, Mobara (JP);
Masateru MORIMOTO, Mobara (JP);
Atsuhiko KATAYAMA, Mobara (JP)(52) **U.S. Cl.**
CPC **G02F 1/133788** (2013.01); **G02B 5/208**
(2013.01); **G02F 1/1337** (2013.01); **G02F**
1/1339 (2013.01); **G02F 1/133514** (2013.01);
G02F 1/136209 (2013.01); **G02F 1/1368**
(2013.01)(73) Assignee: **JAPAN DISPLAY INC.**, Tokyo (JP)(21) Appl. No.: **14/789,349**(22) Filed: **Jul. 1, 2015****Related U.S. Application Data**

(63) Continuation of application No. 14/541,564, filed on Nov. 14, 2014, now Pat. No. 9,104,071, which is a continuation of application No. 14/060,300, filed on Oct. 22, 2013, now Pat. No. 8,908,134, which is a continuation of application No. 13/397,841, filed on Feb. 16, 2012, now Pat. No. 8,593,596.

Foreign Application Priority Data

Mar. 2, 2011 (JP) 2011-045502

(57) **ABSTRACT**

In the step of curing a resin for bonding a TFT substrate and a counter substrate each having an alignment film that has been optically aligned by using UV-light, damage to the alignment film due to the UV-light can be prevented without using a light shielding mask. A UV-light absorption layer is formed between each black matrix on the counter substrate. The TFT and counter substrates are sealed at their periphery by a resin that is cured by UV-light radiated from the counter substrate side. Since the absorption layer has a high absorbability to UV-light at a wavelength of 300 nm or less that degrades the alignment film, damage to the alignment film due to the UV-light for curing the resin can be prevented. Thus, provision of a light shielding mask for shielding the UV-light for the display region can be saved.

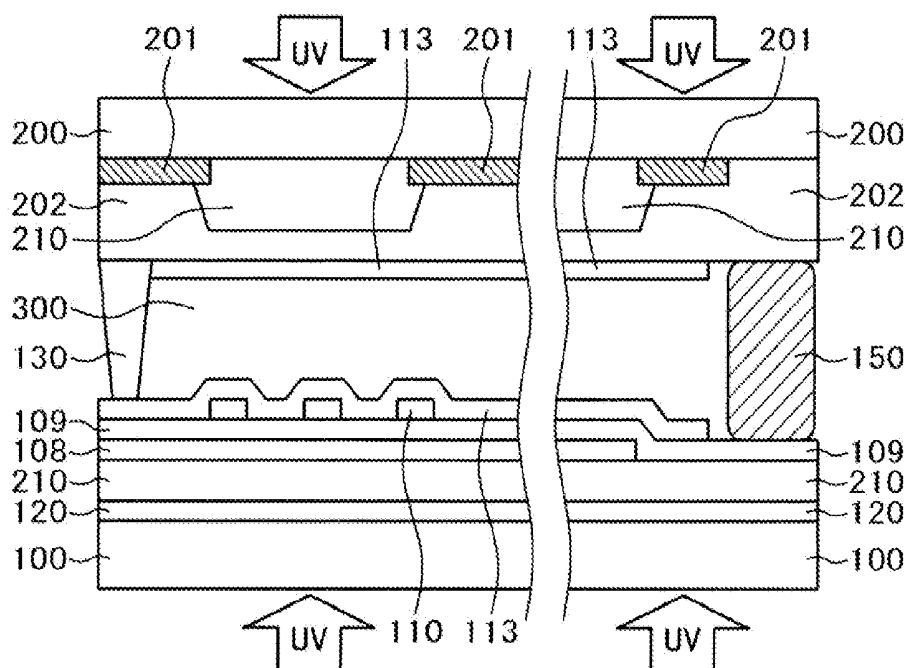


FIG. 1

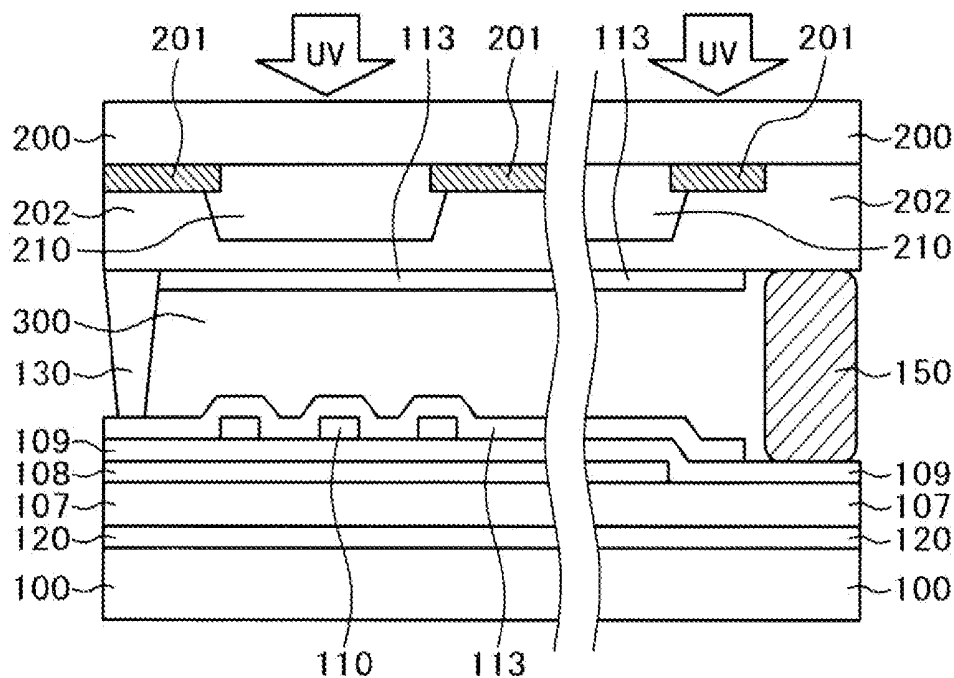


FIG. 2

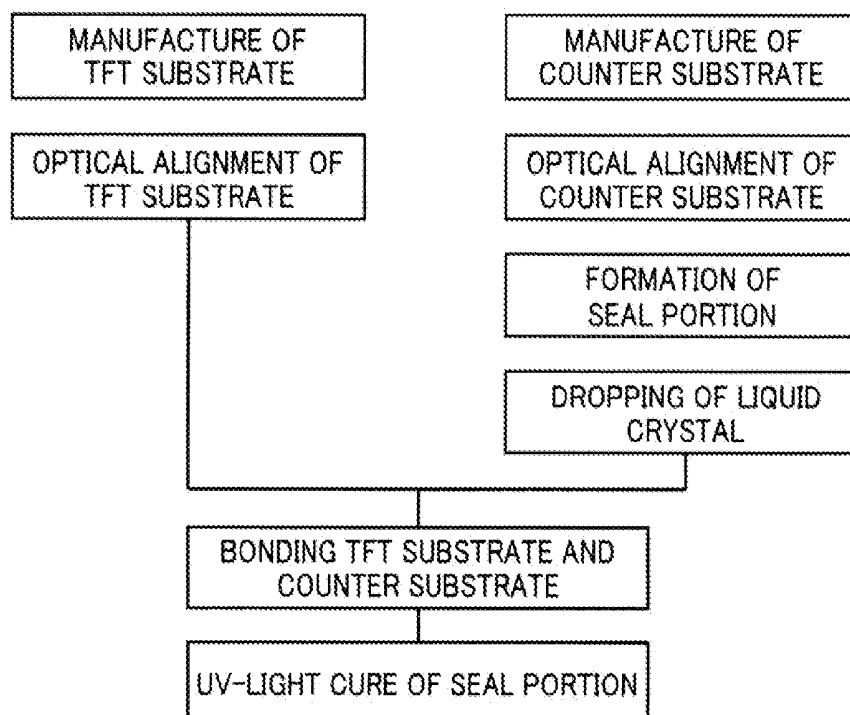


FIG. 3

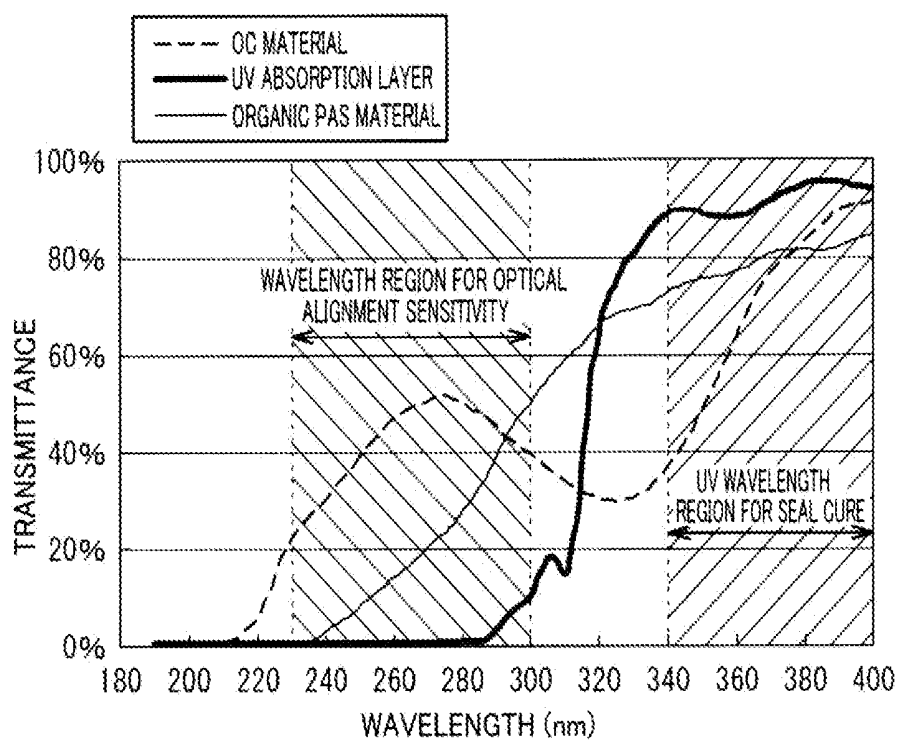


FIG. 4

WAVELENGTH	EXISTENT EMBODIMENT		EMBODIMENT 1	
	SEAL PORTION	DISPLAY PORTION	SEAL PORTION	DISPLAY PORTION
300nm	10.8%	2.7%	10.8%	0.6%
340nm	26.6%	13.6%	26.6%	19.9%

FIG. 5

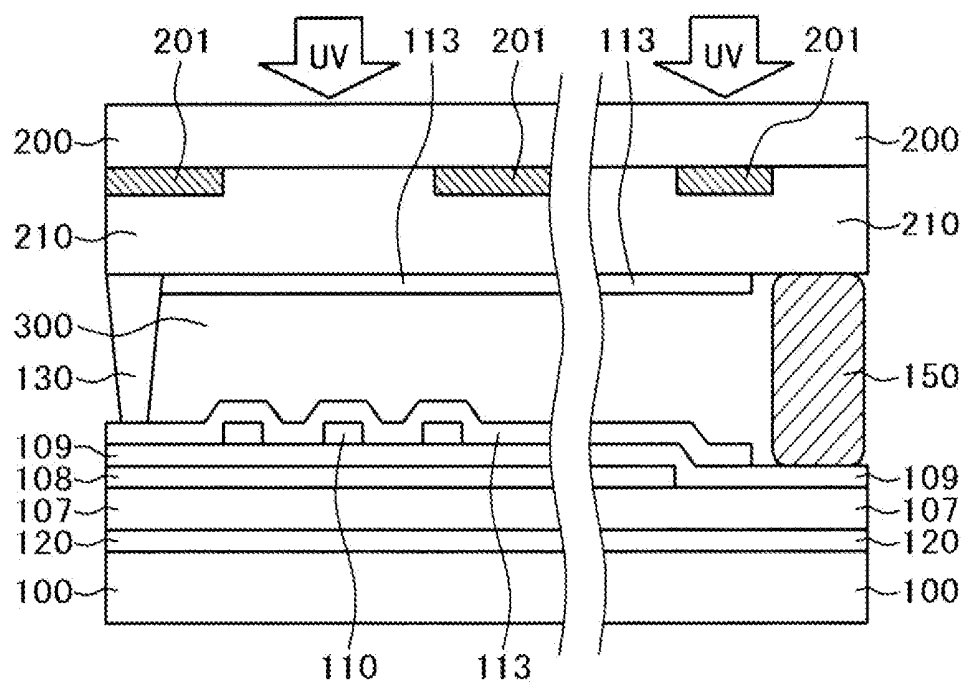


FIG. 6

WAVELENGTH	EXISTENT EMBODIMENT		EMBODIMENT 1		EMBODIMENT 2	
	SEAL PORTION	DISPLAY PORTION	SEAL PORTION	DISPLAY PORTION	SEAL PORTION	DISPLAY PORTION
300nm	10.8%	2.7%	10.8%	0.6%	2.7%	0.2%
340nm	26.6%	13.6%	26.6%	19.9%	65.9%	49.2%

FIG. 9

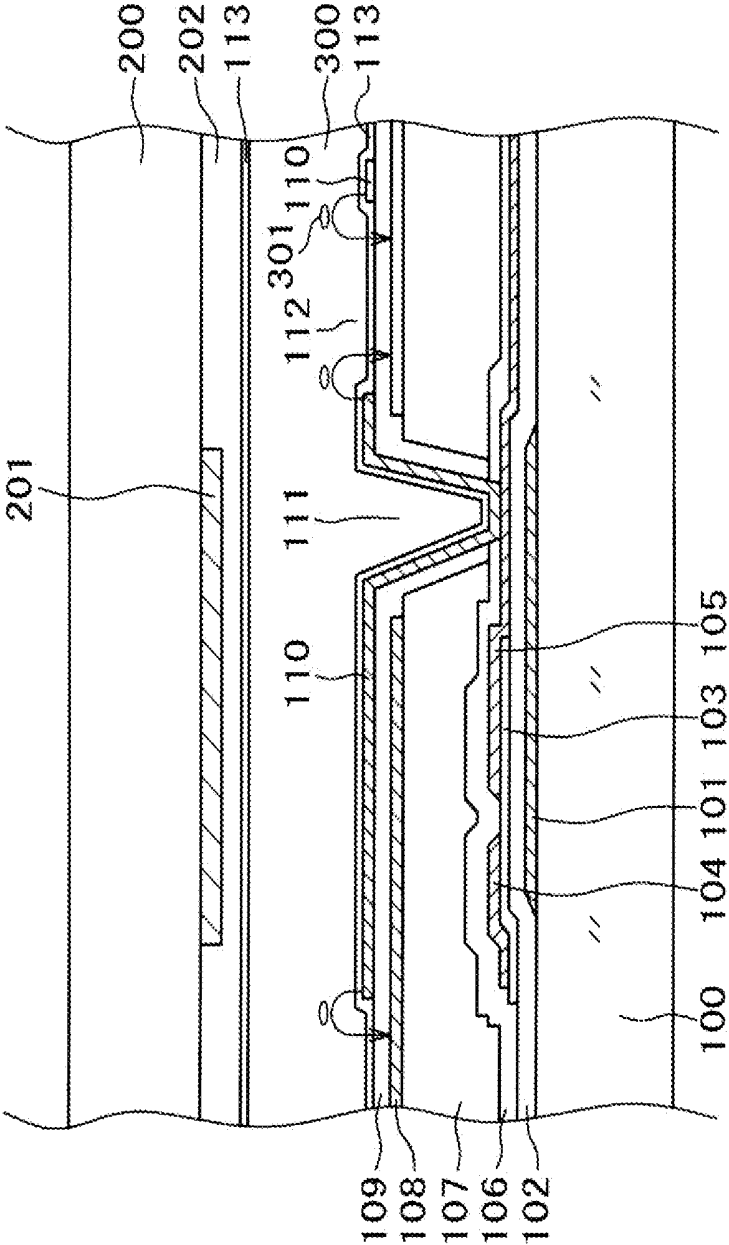


FIG. 10

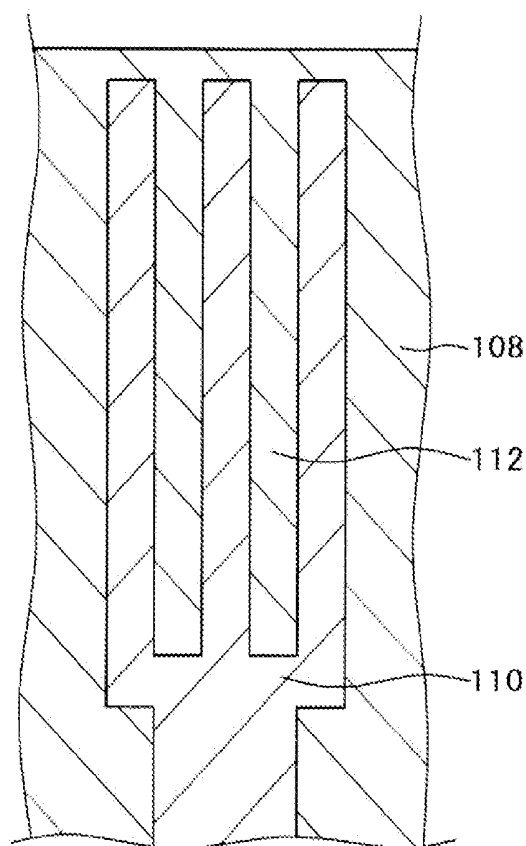
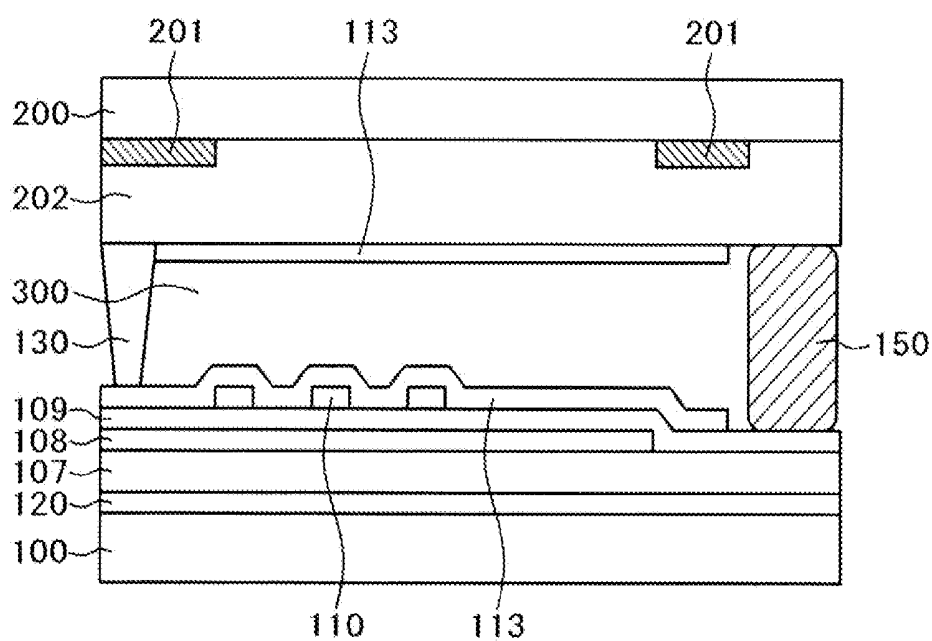


FIG. 11



LIQUID CRYSTAL DISPLAY DEVICE

CLAIM OF PRIORITY

[0001] The present application claims priority from Japanese Patent Application JP 2011-045502 filed on Mar. 2, 2011, the content of which is hereby incorporated by reference into this application.

BACKGROUND OF THE INVENTION

[0002] 1. Field of the Invention

[0003] The present invention relates to a liquid crystal display device. The invention more particularly relates to a liquid crystal display device including an alignment film provided with alignment controllability by irradiation of light.

[0004] 2. Description of the Related Art

[0005] Liquid crystal display devices include a TFT substrate having pixel electrodes, thin film transistors (TFTs), etc. formed in a matrix; a counter substrate opposing the TFT substrate and having black matrices and an overcoat film, etc.; and liquid crystals put between the TFT substrate and the counter substrate. Images are formed by controlling the light transmittance of the liquid crystal molecules of each pixel.

[0006] Since liquid crystal display devices are flat and light in weight, they are applied in various fields, for example, from large-sized display devices such as television sets to mobile phones and DSCs (Digital Still Cameras). For liquid crystal display devices, the view angle characteristic issues a problem. The view angle characteristic is a phenomenon such that the luminance or chromaticity changes from that of when the screen is viewed from the front when the screen is viewed from an oblique direction. The IPS (In Plane Switching) system which operates liquid crystal molecules by a horizontal electric field has a good view angle characteristic.

[0007] As a method of alignment treatment, that is, a method for giving alignment controllability to an alignment film used for liquid crystal display devices, rubbing treatment has been used in the conventional art. Rubbing treatment is performed by rubbing an alignment film with a cloth. On the other hand, there is a method called an optical alignment method which can provide alignment controllability to an alignment film in a contactless manner. Since the performance of the IPS system is better as the pre-tilt angle is smaller, the optical alignment method which in principle does not generate a pre-tilt angle is advantageous.

[0008] The TFT substrate and the counter substrate are bonded at their periphery with a seal material; as the seal material, UV-curable resin is often used. When the display region in which the alignment film is formed is irradiated with UV-light to cure the seal material, the UV-light deteriorates the alignment film. Conventionally, a light shielding mask has been used so that the display region is not irradiated with UV-light upon the UV-irradiation against the seal material.

[0009] However, even when such a mask is used, the UV-light comes around to deteriorate the alignment film at the periphery of the display region. JP-A-H10-221700 discloses a configuration in which the counter substrate is provided with a band pass filter surrounding the outer side of the display region so that it cuts off the UV-light, thereby protecting the alignment film and liquid crystals in the display region from the UV-light by the combination of the light shielding mask and the band pass filter.

SUMMARY OF THE INVENTION

[0010] In a conventional configuration in which a light shielding mask is provided to shroud the display region at the time the seal material is cured by UV-light irradiation, it is necessary to align the light shielding mask to a predetermined position upon exposure. Thus, fabrication steps for this process would be added, and it is also necessary to prepare various sizes and kinds of light shielding masks.

[0011] Further, in a configuration as described in JP-A-H10-221700 in which the counter substrate is provided with a band pass filter formed around the periphery of the display region, there is an overlap between the band pass filter and the seal material. The effect of the band pass filter on the curing of the seal material needs to be taken into consideration. It is also necessary matters such as the bondability between the band pass filter and the seal material as well as the black matrix, etc. around it. Further, even when the band pass filter is formed, a light shielding mask will still be needed.

[0012] The present invention intends to attain a liquid crystal display device employing an alignment film obtained by optical alignment and a UV-light curable resin for a seal material, which does not require the use of a UV-light shielding mask upon UV-curing of the seal material.

[0013] The present invention intends to overcome the problems described above and provides, in a first aspect, a liquid crystal display device comprising: a TFT substrate having an alignment film; a counter substrate having an alignment film, the counter substrate being bonded to the TFT substrate by means of a seal material; and liquid crystals sealed inside the substrates and the seal material; wherein a UV-light absorption layer is formed between each black matrix, the black matrices and the UV-light absorption layer being covered by an overcoat film, the overcoat film being covered by the alignment film; the seal material is a UV-light curable resin; and the transmittance of the UV-light absorption layer to UV-light at a wavelength of 300 nm is lower than that of the overcoat film, and the transmittance of the UV-light absorption layer to UV-light at a wavelength of 340 nm is higher than that of the overcoat film.

[0014] The present invention provides, in a second aspect, a liquid crystal display device comprising: a TFT substrate having an alignment film; a counter substrate having an alignment film, the counter substrate being bonded to the TFT substrate by means of a seal material; and liquid crystals sealed inside the substrates and the seal material; wherein a UV-light absorption layer is formed between each black matrix and over the black matrices, and the alignment film is formed over the UV-light absorption layer; the TFT substrate is covered by a TFT circuit and an organic passivation film covering the TFT circuit, and over the organic passivation film, counter electrodes, an interlayer insulation film, and pixel electrodes are formed in that order, or in the order of the pixel electrodes, the interlayer insulation film, and the counter electrodes; the alignment film is formed over the pixel electrodes or the counter substrate; the seal material is a UV-light curable resin; and the transmittance of the UV-light absorption layer to UV-light at a wavelength of 300 nm is lower than that of the organic passivation film, and the transmittance of the UV-light absorption layer to UV-light at a wavelength of 340 nm is higher than that of the organic passivation film.

[0015] The present invention provides, in a third aspect, a liquid crystal display device comprising: a TFT substrate having an alignment film; a counter substrate having an align-

ment film, the counter substrate being bonded to the TFT substrate by means of a seal material; and liquid crystals sealed inside the substrates and the seal material; wherein a color filter is formed between each black matrix, the black matrices and the color filters being covered by an overcoat film, the overcoat film being covered by the alignment film; the TFT substrate is covered by a TFT circuit and a UV-light absorption layer covering the TFT circuit, and over the UV-light absorption layer, counter electrodes, an interlayer insulation film, and pixel electrodes are formed in that order, or in the order of the pixel electrodes, the interlayer insulation film, and the counter electrodes; the alignment film is formed over the pixel electrodes or the counter substrate; the seal material is a UV-curable resin; and the transmittance of the UV-light absorption layer to UV-light at a wavelength of 300 nm is lower than that of the overcoat film, and the transmittance of the UV-light absorption layer to UV-light at a wavelength of 340 nm is higher than that of the overcoat film.

[0016] The present invention provides, in a fourth aspect, a liquid crystal display device comprising: a TFT substrate having an alignment film; a counter substrate having an alignment film, the counter substrate being bonded to the TFT substrate by means of a seal material; and liquid crystals sealed inside the substrates and the seal material; wherein a UV-light absorption layer is formed between each black matrix, the black matrices and the UV-light absorption layer being covered by an overcoat film, the overcoat film being covered by the alignment film; the TFT substrate is covered by a TFT circuit and a UV-light absorption layer covering the TFT circuit, and over the UV-light absorption layer, counter electrodes, an interlayer insulation film, and pixel electrodes are formed in that order, or in the order of the pixel electrodes, the interlayer insulation film, and the counter electrodes; the alignment film is formed over the pixel electrodes or the counter substrate; the seal material is a UV-curable resin; and the transmittance of the UV-light absorption layer to UV-light at a wavelength of 300 nm is lower than that of the overcoat film and that of the organic passivation layer, and the transmittance of the UV-light absorption layer to UV-light at a wavelength of 340 nm is higher than that of the overcoat film and that of the organic passivation layer.

[0017] According to the present invention, the UV-light absorption layer that absorbs UV-light at a wavelength of 300 nm or less is formed in the display region. Therefore, damaging to the alignment film by the UV-light can be prevented during the UV-irradiation for sealing the TFT substrate and the counter substrate having the alignment films by means of the UV-light curable seal material. Since a light shielding mask for protecting the display region against the UV-light radiated in the UV-irradiation step can be saved, the manufacturing cost of the liquid crystal display device can be reduced.

BRIEF DESCRIPTION OF THE DRAWINGS

[0018] FIG. 1 is a cross sectional view of a liquid crystal display device according to Embodiment 1;

[0019] FIG. 2 is a manufacturing process of a liquid crystal display device according to the present invention;

[0020] FIG. 3 shows the UV-light transmission characteristic of a UV-light absorption layer relative to wavelength;

[0021] FIG. 4 is a table comparing the UV-light transmission characteristics of the liquid crystal display devices of Embodiment 1 and a conventional example;

[0022] FIG. 5 is a cross sectional view of a liquid crystal display device according to Embodiment 2;

[0023] FIG. 6 is a table comparing the UV-light transmission characteristics of the liquid crystal display devices of Embodiment 2 and 1 and the conventional example;

[0024] FIG. 7 is a cross sectional view of a liquid crystal display device according to Embodiment 3;

[0025] FIG. 8 is a cross sectional view of a liquid crystal display device according to Embodiment 4;

[0026] FIG. 9 is a cross sectional view of a display region of an IPS liquid crystal display device;

[0027] FIG. 10 is a plan view showing an example of a pixel electrode of the IPS liquid crystal display device; and

[0028] FIG. 11 is a cross sectional view of the display region and the seal portion of the IPS liquid crystal display device.

DESCRIPTION OF THE PREFERRED EMBODIMENTS

[0029] Prior to the explanation of the embodiments of the present invention, the configuration of an IPS liquid crystal display device to which the present invention is applied is described.

[0030] FIG. 9 is a cross sectional view showing a structure in a display region of an IPS liquid crystal display device. The structure shown in FIG. 9 is the structure generally used at present. In brief, a comb-teeth pixel electrode 110 is formed over a counter electrode 108 formed in a solid coated form with an insulation film 109 put between them. Liquid crystal molecules 301 are rotated by the voltage between the pixel electrode 110 and the counter electrode 108, and the light transmittance of the liquid crystal layer 300 of each pixel is controlled to thereby form an image.

[0031] In FIG. 9, a gate electrode 101 is formed over a TFT substrate 100 formed of glass. The gate electrode 101 is formed in the same layer as the scanning line. The gate electrode 101 is formed from an AlNd alloy and a MoCr alloy stacked thereover.

[0032] A gate insulation film 102 of SiN is formed covering the gate electrode 101. A semiconductor layer 103 of an a-Si film formed of is formed over the gate insulation film 102 at a position opposing the gate electrode 101. The a-Si film forms a channel portion of the TFT, and over the a-Si film, a drain electrode 104 and a source electrode 105 are formed with the channel portion put between them. An n+Si layer (not shown) is formed between the a-Si film and the drain electrode 104 or the source electrode 105. The n+Si layer is for establishing ohmic contact between the semiconductor layer 103 and the drain electrode 104 or the source electrode 105.

[0033] The drain electrode 104 also serves as a video signal line, and the source electrode 105 is connected with the pixel electrode 110. The drain electrode 104 and the source electrode 105 are formed simultaneously in the same layer. In this embodiment, the drain electrode 104 or the source electrode 105 is formed of MoCr alloy. When it is desired to lower the electric resistance of the drain electrode 104 or the source electrode 105, for example, an electrode structure such that an AlNd layer is put between MoCr alloys is used.

[0034] An inorganic passivation film 106 of SiN is formed to cover the TFT. The inorganic passivation film 106 protects, particularly, the channel portion of the TFT against impurities. An organic passivation film 107 is formed over the inorganic passivation film 106. Since the organic passivation film

107 also has a function of planarizing the surface as well as protecting the TFT, the film is formed thick. The thickness is from 1 μm to 4 μm .

[0035] A counter electrode **108** is formed over the organic passivation film **107**. The counter electrode **108** is formed by sputtering ITO (Indium Tin Oxide), a transparent conductive film, over the entire display region. That is, the counter electrode **108** is formed in a planar form. After the counter electrode **108** is formed over the entire surface by sputtering, a portion of the counter electrode **108** is removed by etching to form a through hole **111** so as to establish conduction between the pixel electrode **110** and the source electrode **105**.

[0036] An interlayer insulation film **109** of SiN is formed covering the counter electrode **108**. After the interlayer insulation film **109** is formed, the through hole **111** is formed by etching. The through hole **111** is formed by etching the inorganic passivation film **106** using the interlayer insulation film **109** as a resist.

[0037] Then, ITO which will be the pixel electrode **110** covering the interlayer insulation film **109** and the through hole **111** is formed by sputtering. The pixel electrode **110** is formed by patterning the sputtered ITO. ITO as the pixel electrode **110** is deposited in the through hole **111** as well. The source electrode **105** extending from the TFT and the pixel electrode **110** are connected via the through hole **111** so that video signals are supplied to the pixel electrode **110**.

[0038] FIG. 10 shows an example of the pixel electrode **110**. The pixel electrode **110** is a comb-teeth electrode. Slits **112** are formed between the comb-teeth. A planar counter electrode **108** is formed below the pixel electrode **110** with an interlayer insulation film **109** not illustrated put between them.

[0039] When video signals are applied to the pixel electrode **110**, liquid crystal molecules **301** are rotated by the lines of electric force generated between the pixel electrode **110** and the counter electrode **108** through the slit **112**. The light transmitting the liquid crystal layer **300** is thus controlled, and thereby an image is formed.

[0040] Returning to FIG. 9, an alignment film **113** for aligning the liquid crystal molecules **301** is formed over the pixel electrode **110**. In FIG. 9, a counter substrate **200** is disposed with a liquid crystal layer **300** put between them. Since the device shown in FIG. 9 is a monochromatic liquid crystal display device, a black matrix **201** and an overcoat film **202** covering it are formed at the inner side of the counter substrate **200**.

[0041] While the black matrix **201** is for improving the contrast, it also functions as a light shielding film for the TFT. The overcoat film **202** is formed to moderate the roughness of the surface. An alignment film **113** for determining the initial orientation of the liquid crystals is formed over the overcoat film **202**. The alignment film **113** of the counter substrate side is also processed with an alignment treatment by optical alignment in the same manner as for the alignment film **113** of the TFT substrate side.

[0042] Although not illustrated in FIG. 9, a columnar spacer made of resin is formed on the counter substrate side in order to define the gap between the TFT substrate **100** and the counter substrate **200**. Since the device of FIG. 9 is a monochromatic liquid crystal display device, color filters are not present. In color liquid crystal display devices, color filters of colors such as red, green, blue, etc. are formed at both sides of the black matrix **201**.

[0043] FIG. 9 shows a configuration in which the counter electrode **108** is formed over the organic passivation film **107**, and the comb-teeth pixel electrode **110** is disposed thereover with the interlayer insulation film **109** put between them. By contrast, there is also an IPS device of a configuration in which the pixel electrode **110** is disposed over the organic passivation film **107**, and a comb-teeth counter electrode **108** is disposed thereover with the interlayer insulation film **109** put between them. The present invention can be applied to either of the types of IPS.

[0044] FIG. 11 is a cross sectional view of the display region and the seal portion of the IPS liquid crystal display device shown in FIG. 9 employing optical alignment.

[0045] In FIG. 11, the part from the gate electrode **101** to the inorganic passivation film **106** in FIG. 9 are collectively illustrated as a TFT circuit **120**. In FIG. 11, the TFT circuit **120** is formed over a TFT substrate **100**, an organic passivation film **107** is formed thereover, and a common electrode **108** painted in a solid form is formed over the organic passivation film **107**. A comb-teeth pixel electrode **110** is formed over the common electrode **108** with the interlayer insulation film **109** put between them, and the pixel electrode **110** is covered by an alignment film **113**.

[0046] In FIG. 11, black matrices **201** are formed on a counter substrate **200**. An overcoat film **202** is formed to cover the black matrices **201**, and an alignment film **113** is formed over the overcoat film **202**. Further, a columnar spacer **130** is formed between the counter substrate **200** and the TFT substrate **100**.

[0047] In FIG. 11, a seal material **150** is formed at the periphery of the counter substrate **200** and the TFT substrate **100**, and a liquid crystal layer **300** is sealed in the inner side of the seal material **150**. In FIG. 11, the seal material **150** is formed between the interlayer insulation film **109** of the TFT substrate **100** and the overcoat film **202** of the counter substrate **200**. The alignment films **113** do not exist at the portion the seal material **150** is formed. This is because the alignment film **113** has a property of lowering the adhesion of the seal material **150**.

[0048] In FIG. 11, the alignment film **113** is optically aligned by UV-light at a wavelength of 300 nm or less and the seal material **150** is cured by UV-light at a wavelength of 340 nm or more. At the time the seal material **150** is to be cured, the optical alignment for the alignment film **113** will already be finished. If the UV-light at a wavelength of 300 nm or less is applied again to the alignment film **113** after finishing the alignment treatment, the alignment film **113** will deteriorate.

[0049] The degradation can be prevented by filtering the UV-light for curing the seal material **150** and use the UV-light that has been cut off the light at a wavelength of 300 nm or less, or by using a UV-light shielding mask to thereby prevent radiation of the UV-light to the alignment film **113**. However, forming the filter for UV-light increases the manufacturing cost, and the filter has to be replaced frequently because the UV-light deteriorates the filter. On the other hand, the method of using the light screening mask involves the problem as described herein earlier (refer to SUMMARY OF THE INVENTION).

[0050] The present invention described in the following by way of embodiments provides a configuration that can prevent UV-degradation of the alignment film without providing a filter for the UV-light light source and using a light shielding mask upon UV-curing of the seal material.

EMBODIMENT 1

[0051] FIG. 1 is a cross sectional view showing the structure of a liquid crystal display device of Embodiment 1. A cross sectional view of the display region is shown on the left and a cross sectional view of the seal portion is shown on the right.

[0052] In FIG. 1, a TFT circuit 120 is formed over a TFT substrate 100. The TFT circuit 120 collectively represents the configuration from the gate electrode 101 to the inorganic passivation film 106 in FIG. 9. The same applies to the following drawings.

[0053] The device shown in FIG. 1 is a monochromatic liquid crystal display device. Since the configuration of FIG. 1 is identical with that of FIG. 11 except that a UV-light absorption layer 210, a feature of the present invention, is formed between each black matrix 201, detailed description for the structure is omitted. The arrow UV in FIG. 1 represents the UV-light for curing a seal member 150.

[0054] FIG. 2 is a flow of manufacturing of the liquid crystal display device of Embodiment 1. In FIG. 2, the manufacturing flow for the TFT substrate 100 is shown on the left. Since the manufacturing process for the TFT substrate 100 has been described with reference to FIG. 9, details thereof are omitted. After an alignment film 113 is coated over the TFT substrate 100 and then baked, an alignment treatment is performed on the alignment film 113 by using UV-light. A wavelength of the UV-light effective for the alignment treatment is 300 nm or less.

[0055] Since the manufacturing process for the counter substrate 200 shown on the right side of FIG. 2 has been described with reference to FIG. 9, its details are omitted. After coating and baking the alignment film 113, an alignment treatment is performed upon the alignment film 113 by using UV-light at a wavelength of 300 nm or less. Then, a seal material 150 is formed on the counter substrate 200 and liquid crystals are dropped into the region surrounded by the seal material 150.

[0056] Next, the TFT substrate 100 and the counter substrate 200 are bonded by means of the seal material 150. As shown in FIG. 1, UV-light is radiated on the counter substrate side to cure the seal material 150. A light shielding mask is not used at this process. The seal material 150 reacted and cured by UV-light at a wavelength of 340 nm or more, however, the UV-light used here includes not only UV-light at a wavelength of 340 nm or more but also UV-light at a wavelength of 300 nm or less. In the conventional configuration, when the UV-light includes UV-light at a wavelength of 300 nm or less, the alignment film is degraded if the seal material 150 is cured without using the light shielding mask.

[0057] In the portion where a black matrix 201 is formed, the black matrix 210 yields a light shielding effect against the UV-light. However, in the conventional embodiment, since only the overcoat film 202 is present at the portions where the black matrices 201 are not formed, the UV-light at a wavelength of 300 nm or less transmits the overcoat film 202. In this embodiment, a UV-light absorption layer 210 is formed between a black matrix 201 and a black matrix 201 as to shield particularly the UV-light at a wavelength of 300 nm or less. Thus, degradation of the alignment film can be prevented without disposing a light shielding mask.

[0058] FIG. 3 is a graph showing the UV-light transmittances of the organic materials used in the present invention: that is, the overcoat film 202 (material for OC), the organic passivation film 107 (organic PAS material), and the UV-light

absorption layer 210 (UV absorption layer) which are. As shown in FIG. 3, the transmittance of the UV-light absorption layer 210 is extremely low to UV-light at a wavelength of 300 nm or less. On the other hand, the layer has a high transmittance to UV-light at a wavelength of 340 nm or more.

[0059] In FIG. 3, the transmittance of the UV-light absorption layer 210 to the UV-light at a wavelength of 300 nm is 10%, and the transmittance of the UV-light absorption layer 210 to the UV-light at a wavelength of 340 nm is 90%. The values represent those that can be obtained when the UV-light absorption layer 210 has a thickness of 1 μ m. The table in FIG. 4 shows the result of an evaluation of the transmittances in the display region and the seal portion of the liquid crystal display device shown in FIG. 1 to the UV-light at a wavelength of 300 nm and at a wavelength of 340 nm, for the conventional example and the present embodiment provided with the UV-light absorption layer 210, respectively.

[0060] FIG. 4 shows the intensity of the UV-light that were radiated from the counter substrate 200 side, transmitted through the liquid crystal display device, and then measured at the TFT substrate 100 side.

[0061] In FIG. 4, since the configurations of the seal portions 150 of the conventional example and this embodiment are same, the UV-light transmittance is identical. On the other hand, in the display portion, since the UV-light absorption layer 210 exists in this embodiment, while the transmittance to the UV-light at a wavelength of 300 nm is 2.7% in the conventional example, it is lowered to 0.6% in this embodiment. As can be seen from FIG. 3, the transmittance to UV-light at a wavelength of 300 nm or less is further lowered. Therefore, according to this embodiment, since the UV-light at a wavelength of 300 nm or less that affects the alignment film 113 scarcely transmits in the display region, the damage to the alignment film 113 due to the UV-light can be inhibited.

[0062] However, the transmittance to the UV-light at a wavelength of 340 nm is 13.6% in the conventional example, whereas it increases to 19.9% in this embodiment. This is because the UV-light absorption layer shows higher transmittance than that of the overcoat film 202 to the wavelength at a wavelength of 340 nm or more. However, since the UV-light at a wavelength of 340 nm or more causes no damage to the alignment film 113, practically there would be no problem.

[0063] The table in FIG. 4 shows examples. The film thickness of the UV-light absorption layer 210, etc. actually varies. The effect of the invention can be obtained even when the thickness of the UV-light absorption layer 210 and other elements varies, so long as the transmittance to the UV-light at a wavelength of 300 nm or less in the display region is 1% or lower, and the transmittance to the UV-light at a wavelength of 340 nm in the seal portion is 20% or higher.

EMBODIMENT 2

[0064] FIG. 5 is a cross sectional view showing the structure of a liquid crystal device of Embodiment 2. A cross sectional view of the display region is shown on the left and the cross sectional view of the seal portion is shown on the right. The configuration of FIG. 5 is different from that of Embodiment 1 in FIG. 1 in that a UV-light absorption layer 210 is formed instead of the overcoat film. In FIG. 5, the UV-light absorption layer 210 is formed not only in the display region but also in the seal portion instead of the overcoat film.

[0065] In FIG. 5, after the TFT substrate 100 is bonded to the counter substrate 200 by means of the seal material 150, a

UV-light is radiated from the counter substrate **200** side to cure the seal material **150** in the same manner as performed in Embodiment 1. Further, in this embodiment, a light shielding mask for preventing radiation of the UV-light to the display region is not used as with Embodiment 1.

[0066] The transmittance of the UV-light absorption layer **210** and the overcoat film **202** to UV-light is as shown in FIG. 3. The UV-light absorption layer **210** has a lower transmittance to UV-light at a wavelength of 300 nm or less and shows a higher transmittance to UV-light at a wavelength of 340 nm or more compared with the overcoat film **202**. Accordingly, even if the UV-light is radiated without using a light shielding mask, only an extremely small amount of the UV-light at a wavelength of 300 nm or less reaches the alignment film **113** in the display region. The effect of the UV-light on the alignment film present in the display region is extremely small.

[0067] The table shown in FIG. 6 compares the transmittances of UV-light at a wavelength of 300 nm and UV-light at a wavelength of 340 nm in the display portion and in the seal portion of this embodiment and Embodiment 1 and the conventional example. The measuring method is similar to that taken for the measurement for FIG. 4, the UV-light is radiated from the counter substrate **200** side and the degree of transmittance of the UV-light are measured at the TFT substrate **100** side and compared.

[0068] In the seal portion **150**, different from the conventional example and Embodiment 1, the UV-light absorption layer **210** is formed instead of the overcoat film **202** in this embodiment. While the transmittance to the UV-light at a wavelength of 300 nm is as low as 2.7%, the transmittance to the UV-light at a wavelength of 340 nm is as high as 49.2%. That is, since the UV-light at a wavelength of 340 nm for curing the seal material **150** is less absorbed by the UV-light absorption layer **210**, the seal material is irradiated efficiently with the UV-light. Therefore, the seal material **150** can be cured efficiently by the UV-light in this embodiment.

[0069] In the display region, regarding the UV-light at a wavelength of 300 nm, since the overcoat film **202** is entirely replaced by the UV-light absorption layer **210**, the transmittance is more lowered than that of Embodiment 1, to 0.2%. Accordingly, since the UV-light at a wavelength of 300 nm is cut off more efficiently in this embodiment, damage to the alignment film **113** can be prevented more efficiently. Although the transmittance to the UV-light at a wavelength of 340 nm in the display region is as high as 49.2%, the effect caused by the UV-light at a wavelength of 340 nm on the alignment film is small, so it does not damage the alignment film **113**.

[0070] As described above, the seal material **150** can be cured by UV-light without damaging the alignment film **113** even when a light shielding mask is not used in this embodiment as well.

[0071] As shown in FIG. 5, in this embodiment, a columnar spacer **130** is formed on the UV-light absorption layer **210**. By using the same material as the UV-light absorption layer **210** for the columnar spacer **130**, the UV-light absorption layer **210** and the columnar spacer **130** can be formed simultaneously.

[0072] As an example of this process, a UV-light absorption layer of a thickness equal to the total thickness of the UV-light absorption layer **210** and the columnar spacer **130** is coated over the counter substrate **200**. Then, only the portion other than the columnar spacer **130** is removed by etching to a predetermined thickness by controlling the exposure dose in

photolithography. The columnar space **130** and the UV-light absorption layer **210** can thus be formed simultaneously in the process of forming the columnar spacer **130**, resulting in a reduced manufacturing cost.

EMBODIMENT 3

[0073] FIG. 7 shows a cross sectional view of a liquid crystal display device of Embodiment 3 according to the invention. Different from Embodiment 1 and Embodiment 2, the device shown in FIG. 7 is a color liquid crystal display device. Color filters **220** are formed between each black matrix **201** in the counter substrate **220**. On the other hand, in the TFT substrate **100**, a UV light absorption layer **210** is formed instead of an organic passivation film **107**. Since other portions have the same configuration as those of Embodiment 1 in FIG. 1, descriptions thereof are omitted.

[0074] In this embodiment, a counter substrate **200** having an optically aligned alignment film **113** and a TFT substrate **100** having an optically aligned alignment film **113** are sealed at their periphery with a UV-curable seal material **150**. As shown in FIG. 7, UV-light for curing the seal material **150** is radiated from the TFT substrate **100** side. The relationship of the UV-light transmittances of the organic passivation film **107** and the UV-light absorption layer **210** are as shown in FIG. 3. That is, the UV-light absorption layer **210** efficiently cuts off the UV-light at a wavelength of 300 nm or less, and it efficiently transmits the UV-light at a wavelength of 340 nm or more, compared with the organic passivation film **107**.

[0075] In the configuration shown in FIG. 7, when UV-light is radiated from the TFT substrate **100** side, since the UV-light absorption layer **210** is formed instead of the organic passivation film **107** at the TFT substrate **100** side, UV-light at a wavelength of 300 nm or less which may damage the alignment film **113** is efficiently cut off in the display region. Although UV-light at a wavelength of 340 nm or more is more likely to transmit through the UV-light absorption layer **210** in the display region, the UV-light at a wavelength of 340 nm or more does not damage the alignment film **113**, so there is no problem.

[0076] On the other hand, for the seal material **150** at the seal portion, since the UV-light absorption layer **210** formed over the TFT substrate **100** has higher transmittance to the UV-light at a wavelength of 340 nm or more, the seal material **150** can be cured efficiently. While also the UV-light at a wavelength of 300 nm or less is less radiated to the seal material **150**, the UV-light within this range causes less effect on the curing of the seal material. Thus, no problem arises.

[0077] As described above, the seal material **150** can be cured by UV-light with no damage on the alignment film **113** due to the UV-light radiation without using a light shielding material in this embodiment as well.

EMBODIMENT 4

[0078] FIG. 8 is a cross sectional view of a liquid crystal display device showing Embodiment 4 of the invention. The device shown in FIG. 8 is also a monochromatic liquid display device as with those of Embodiment 1 and Embodiment 2. In FIG. 8, a UV-light absorption layer **210** is formed between each black matrix **201** as in Embodiment 1. On the other hand, a UV-light absorption layer **210** is formed instead of an organic passivation film **107** at the TFT substrate **100** side as with Embodiment 3. That is, this embodiment has a configuration such that the UV-light at a wavelength of 300

nm or less is efficiently cut off at both the counter substrate **200** side and TFT substrate **100** side, and the transmittance to the UV-light at a wavelength of 340 nm or more is high also at both sides.

[0079] In this embodiment, UV-light can be radiated from both the counter substrate **200** side and the TFT substrate **100** side as shown in FIG. 8. Since it is adapted such that the UV-light at a wavelength of 300 nm or less is efficiently cut off at both the counter substrate **200** side and the TFT substrate **100** side, the UV-light does not damage the alignment film **113**.

[0080] On the other hand, the UV-light at a wavelength of 340 nm or higher is transmitted efficiently, particularly in the TFT substrate **100** side. Further, also in the counter substrate **200** side, the transmittance of the seal portion **3** to the UV-light at a wavelength of 340 nm or more is maintained at a level equivalent to that of the conventional example.

[0081] Therefore, according to this embodiment, since the radiation dose of the UV-light at a wavelength of 340 nm or more to the seal material **150** can be increased remarkably, the seal material **150** can be cured by UV-light within a shorter time period. Further, the seal material **150** can be cured by UV-light with no damage to the alignment film **113** without using a light shielding mask as with Embodiment 1 to 3.

1-8. (canceled)

9. A liquid crystal display device comprising:

a TFT substrate having a first alignment film;

a counter substrate having a second alignment film and a pair of light shielding regions, the counter substrate being bonded to the TFT substrate by a seal material; and liquid crystals sealed inside the substrates and the seal material;

wherein the counter substrate has a UV-light absorption layer formed between the pair of light shielding regions, the second alignment film is optically aligned by UV-light, the second alignment film is formed between the UV-light absorption layer and the liquid crystals, the seal material is a UV-light curable resin, and the transmittance of the UV-light absorption layer to UV-light at a wavelength of 300 nm is lower than that to UV-light at a wavelength of 340 nm.

10. The liquid crystal display device according to claim 9, wherein an overcoat layer is formed between the UV-light absorption layer and the second alignment layer, the transmittance of the UV-light absorption layer to UV-light at a wavelength of 300 nm is lower than that of the overcoat film, and the transmittance of the UV-light absorption layer to UV-light at a wavelength of 340 nm is higher than that of the overcoat film.

11. The liquid crystal display device according to claim 10, wherein the TFT substrate has an organic passivation film formed between the TFT substrate and the first alignment film,

the first alignment film is optically aligned by UV-light, the transmittance of the UV-light absorption layer to UV-light at a wavelength of 300 nm is lower than that of the organic passivation film, and

the transmittance of the UV-light absorption layer to UV-light at a wavelength of 340 nm is higher than that of the organic passivation film.

12. The liquid crystal display device according to claim 11, wherein the seal material is a UV-curable resin that is cured by UV-light at a wavelength of 340 nm or more; and

the alignment film is optically aligned by UV-light at a wavelength of 300 nm or less.

13. The liquid crystal display device according to claim 12, wherein the liquid crystal display device is a monochromatic liquid crystal display device.

14. The liquid crystal display device according to claim 12, wherein a color filter is formed between the counter substrate and the overcoat layer.

15. The liquid crystal display device according to claim 9, wherein the TFT substrate has an organic passivation film formed between the TFT substrate and the first alignment film,

the first alignment film is optically aligned by UV-light, the transmittance of the UV-light absorption layer to UV-light at a wavelength of 300 nm is lower than that of the organic passivation film, and the transmittance of the UV-light absorption layer to UV-light at a wavelength of 340 nm is higher than that of the organic passivation film.

16. The liquid crystal display device according to claim 15, wherein the liquid crystal display device is a monochromatic liquid crystal display device.

17. The liquid crystal display device according to claim 12, wherein a color filter is formed between the counter substrate and the overcoat layer.

18. The liquid crystal display device according to claim 9, wherein the seal material is a UV-curable resin that is cured by UV-light at a wavelength of 340 nm or more; and the alignment film is optically aligned by UV-light at a wavelength of 300 nm or less.

19. The liquid crystal display device according to claim 9, wherein the liquid crystal display device is a monochromatic liquid crystal display device.

20. The liquid crystal display device according to claim 9, wherein a color filter is formed between the counter substrate and the overcoat layer.

21. A liquid crystal display device comprising:

a TFT substrate having a first alignment film;

a counter substrate having a second alignment film and a light shielding film, the counter substrate being bonded to the TFT substrate by a seal film; and

liquid crystals sealed inside the substrates and the seal material;

wherein the counter substrate has an overcoat layer formed between the counter substrate and the second alignment film,

the TFT substrate has a UV-light absorption layer formed between the TFT substrate and the first alignment film, the first alignment film and the second alignment film are optically aligned by UV-light,

the second alignment film is formed between the light shielding film and the liquid crystals,

the seal material is a UV-light curable resin, and

the transmittance of the UV-light absorption layer to UV-light at a wavelength of 300 nm is lower than that to UV-light at a wavelength of 340 nm.

22. The liquid crystal display device according to claim 21, wherein:

the transmittance of the UV-light absorption layer to UV-light at a wavelength of 300 nm is lower than that of the overcoat film, and the transmittance of the UV-light absorption layer to UV-light at a wavelength of 340 nm is higher than that of the overcoat film.

23. The liquid crystal display device according to claim **21**, wherein:

a color filter is formed between the overcoat layer and the counter substrate.

24. The liquid crystal display device according to claim **21**, wherein:

the TFT substrate has TFT formed between the UV-light absorption layer and the TFT substrate, and

the TFT substrate has a counter electrode, an interlayer insulation film, and a pixel electrode between the UV-light absorption layer and the first alignment film.

25. The liquid crystal display device according to claim **21**, wherein:

the seal material is a UV-curable resin that is cured by UV-light at a wavelength of 340 nm or more; and
the alignment film is optically aligned by UV-light at a wavelength of 300 nm or less.

* * * * *

专利名称(译)	液晶显示装置		
公开(公告)号	US20150309373A1	公开(公告)日	2015-10-29
申请号	US14/789349	申请日	2015-07-01
[标]申请(专利权)人(译)	国松登诚一郎 松本YUKO 富冈靖 森本昌辉 片山笃		
申请(专利权)人(译)	国松，登诚一郎 松本裕子 富冈，靖 森本，昌辉 片山笃		
当前申请(专利权)人(译)	日本展示INC.		
[标]发明人	KUNIMATSU NOBORU MATSUMOTO YUKO TOMIOKA YASUSHI MORIMOTO MASATERU KATAYAMA ATSUHIRO		
发明人	KUNIMATSU, NOBORU MATSUMOTO, YUKO TOMIOKA, YASUSHI MORIMOTO, MASATERU KATAYAMA, ATSUHIRO		
IPC分类号	G02F1/1337 G02F1/1368 G02F1/1335 G02F1/1362 G02B5/20 G02F1/1339		
CPC分类号	G02F1/133788 G02B5/208 G02F1/1337 G02F1/1339 G02F1/133707 G02F1/136209 G02F1/1368 G02F1/1393 G02F1/133514 G02F1/1303 G02F1/133509 G02F1/133512 G02F1/1341 G02F2001 /13398 G02F2201/086 G02F2203/055 Y10T428/1005		
优先权	2011045502 2011-03-02 JP		
其他公开文献	US9201273		
外部链接	Espacenet USPTO		

摘要(译)

在固化用于粘合TFT基板和対向基板的树脂的步骤中，每个都具有通过使用UV光光学对准的取向膜，可以在不使用光的情况下防止由于UV光导致的取向膜的损坏。屏蔽罩。在対向基板上的每个黑色矩阵之间形成UV光吸收层。 TFT和対置基板在其周边处通过树脂密封，该树脂通过从対向基板侧辐射的UV光固化。由于吸收层对波长为300nm或更小的紫外光具有高吸收性而使取向膜劣化，因此可以防止由于用于固化树脂的紫外光而对取向膜造成的损坏。因此，可以节省用于屏蔽显示区域的UV光的遮光掩模。

